Gurmeet Singh

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https://swiftgurmeet.github.io/resume/

Summary

I have over 25 years of leading edge technical experience both as a leader and an individual contributor with a record of highly effective, flawless and prolific execution. My strengths include good communication and analytical skills, breadth of knowledge and ingenuity.

Experience

[16-17] CONSULTANT, ZGLUE INC.

- Physical design methodology and netlist-to-gds flow development in tcl using Cadence toolset. Also Assura physical verification and logical equivalence (lec) flows.
- Hierarchical implementation of an instance array design including floorplanning, power grid, pin placement, place and route, logical equivalence and physical verification.
- Abstract generation of analog macros and hierarchical instance to allow for through the block routing.
- Mixed-signal custom CAD support including SKILL programming
- Setup Virtuoso QRC extraction flow for full chip STA, set up and run full chip STA with Tempus, set up and run full chip LEC with Conformal. Silicon success.

[15-16] MACHINE LEARNING/SOFTWARE ENGINEER

- Data Science/Machine Learning/Programming Student - See courses below
- Kaggle Participant (https://www.kaggle.com/gary347)
- Swift iOS Programming

[13-14] QUALCOMM TECHNOLOGIES, SENIOR STAFF ENGINEER

Top level floorplan, power grid with multiple power domains, using CPF/UPF for a mixed signal design, automated floorplan generation with Tcl. Wrote power intent CPF from scratch. Full chip formal (LEC) and low power (CLP) verification using Cadence tools. Apache Redhawk EM/IR debug and fixes. My leadership enabled a rare ahead of schedule tapeout. Received two Qualstars. Silicon success (WCD9335).

[12-13] CADENCE DESIGN SYSTEMS, STAFF APPLICATION ENGINEER

Developed complete, automated rtl2gds flow (14nm/finFET) using Cadence tools. Using the same, implemented an ARM A9 design @ 2.4GHz. Implemented a 28nm DDR-PHY IP for tapeout.

[11-12] SANDFORCE INC., PRINCIPAL ENGINEER

- Developed a 40 nm automated and optimized, tapeout ready, Cadence based implementation flow.
- Wrote Tcl scripts for a correct by construction, tunable flow used for all blocks.
- Developed automated, tapeout ready, STA setup using Primetime-SI using Tcl/Perl scripts.
- Implemented several large blocks at tapeout quality using the above flow ; the resulting GDSII were timing, LEC, LVS/DRC clean. Silicon success.
- Helped grow the size and capability of the physical design team and lead technical direction.

[08-11] CONTRACTOR/ENGINEER @(MULTIPLE)

- Setup 40nm Cadence based, automated, tapeout ready, block level implementation flow.
- Hierarchical physical implementation flow in 65nm technology using Cadence.
- Telecom ASIC: Implementation of two large blocks using Magma. Silicon Success.
- 65nm WiFi ASIC: Implementation of large block using Magma. Silicon Success.
- 65nm WiFi ASIC: Full chip EM/IR signoff using Apache-Redhawk. Silicon Success.

[06-08] TERANETICS, PRINCIPAL ENGINEER

130nm/65nm 10GBASE-T PHY ASIC: Implement many large blocks, some using x-route. Automate implementation, static timing analysis, logical equivalence and physical verification flows. Power estimation; power reduction using special cells. Silicon Success.

[04-06] AIRGO NETWORKS, PHYSICAL DESIGN MANAGER

Multiple WiFi ASICs: Implement many blocks using Magma. Automate PTSI STA, formal, Calibre PV flows. Full chip EM/IR signoff using Apache-Redhawk. Tapeout signoff/jobview. ECOs, I/O Spice sims, IP integration, Methodology, project management. Silicon success.

[01-04] TRANSMETA, SENIOR MEMBER, TECHNICAL STAFF

1.2/1.8GHz Efficeon CPUs: Implement Hypertransport PnR blocks; Register File design. ECOs. Setup latch compatible STA flow. Array and noise methodologies. Silicon Success.

[99-01] SUN MICROSYSTEMS, MEMBER, TECHNICAL STAFF

- UltraSparc V CPU: CAM Register File, Custom logic circuit design
- 1.2GHz UltraSparc III CPU: Port a dozen 130nm dynamic circuit blocks, including adders up to 64-bits, from 180nm to 130nm. Silicon success.

[97-99] INTEL CORPORATION, DESIGN ENGINEER

- 833MHz Pentium III Xeon CPU: High speed dynamic circuit design for L2$ ECC, L2$ STA/EM/IR verification. Silicon success.
- 600 MHz Pentium III CPU : GTL I/O circuit design. Silicon success.

[94-97] ST MICROELECTRONICS, DESIGN ENGINEER

Circuit Design of 32kx8, 128kx8 SRAMs. Silicon success. CAD setup. Reverse engineer a register file and re-implement, verify functionality using verilog switch level simulation. Silicon success.

Education

I was the best student in my class for all seven years of college level education, including four at India's premium engineering institution.

[2015-2016]: ONLINE COURSERA COURSES
· Machine Learning
· Machine Learning With Big Data
· Practical Machine Learning
· R Programming
· Statistical Inference
· Reproducible Research
· Regression Models
· Functional Programming Principles in Scala
· Object Oriented Programming in Java
· Financial Markets
· Graph Analytics for Big Data
· Hadoop Platform and Application Framework
· The Data Scientist's Toolbox
· Getting and Cleaning Data
· Exploratory Data Analysis
· Developing Data Products
· Introduction to Big Data
· Introduction to Big Data Analytics
· HTML, CSS and Javascript for Web Developers

[12/2006] U.C. BERKELEY EVENING COURSE

Introduction to Digital Signal Processing Course, UC Berkeley, A Grade

[1989-93] M.ENGG., ELECTRICAL COMM, INDIAN INSTITUTE OF SCIENCE.

First class with distinction. Alumni medal, Best Student, 1990-93

[1986-89] B.SC., PHYSICS, DELHI UNIVERSITY.

First class with distinction, Gold medal, Best Student: 1987/88/89.